Notice for TAIYO YUDEN Products

Please read this notice before using the TAIYO YUDEN products.

! REMINDERS

Product Information in this Catalog

Product information in this catalog is as of March 2023. All of the contents specified herein and production status of the products listed in this catalog are subject to change without notice due to technical improvement of our products, etc. Therefore, please check for the latest information carefully before practical application or use of our products.

Please note that TAIYO YUDEN shall not be in any way responsible for any damages and defects in products or equipment incorporating our products, which are caused under the conditions other than those specified in this catalog or individual product specification sheets.

Approval of Product Specifications

Please contact TAIYO YUDEN for further details of product specifications as the individual product specification sheets are available. When using our products, please be sure to approve our product specifications or make a written agreement on the product specification with TAIYO YUDEN in advance.

Pre-Evaluation in the Actual Equipment and Conditions

Please conduct validation and verification of our products in actual conditions of mounting and operating environment before using our products.

Limited Application

1. Equipment Intended for Use

The products listed in this catalog are intended for general-purpose and standard use in general electronic equipment for consumer (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment including, without limitation, mobile phone, and PC) and other equipment specified in this catalog or the individual product specification sheets, or the equipment approved separately by TAIYO YUDEN.

TAIYO YUDEN has the product series intended for use in the following equipment. Therefore, when using our products for these equipment, please check available applications specified in this catalog or the individual product specification sheets and use the corresponding products.

Application	Product Series	Quality Grade '3	
Application	Equipment *1 Category (Part Number Code *2)		
Automotive	Automotive Electronic Equipment (POWERTRAIN, SAFETY)	А	1
Adiomotive	Automotive Electronic Equipment (BODY & CHASSIS, INFOTAINMENT)	С	2
Industrial	Telecommunications Infrastructure and Industrial Equipment	В	2
Medical	Medical Devices classified as GHTF Class C (Japan Class III)	M	2
iviedicai	Medical Devices classified as GHTF Classes A or B (Japan Classes I or II)	L	3
Consumer	General Electronic Equipment	S	3
	Only for Mobile Devices *4	E	4

^{*}Notes:1. Based on the general specifications required for electronic components for such equipment, which are recognized by TAIYO YUDEN, the use of each product series for the equipment is recommended. Please be sure to contact TAIYO YUDEN before using our products for equipment other than those covered by the product series.

- 3. Each product series is assigned a "Quality Grade" from 1 to 4 in order of higher quality. Please do not incorporate a product into any equipment with a higher Quality Grade than the Quality Grade of such product without the prior written consent of TAIYO YUDEN.
- 4. The applications covered by this product series are limited to mobile devices (smartphone, tablet PC, smartwatch, handheld game console, etc.) among general electronic equipment for consumer. The design, specifications and operating environment, etc. differ from those of the product series for "General Electronic Equipment" (Category: S), so please check the individual product specification sheets for details. The product series for "General Electronic Equipment" (Category: S) can also be used for mobile devices.

^{2.} On each of our part number, the 2nd code from the left is a code indicating the "Category" as shown in the above table. For details, please check the explanatory materials regarding the part numbering system of each of our products.

[▶] This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our product specification sheets. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our website (http://www.ty-top.com/).

2. Equipment Requiring Inquiry

Please be sure to contact TAIYO YUDEN for further information before using the products listed in this catalog for the following equipment (excluding intended equipment as specified in this catalog or the individual product specification sheets) which may cause loss of human life, bodily injury, serious property damage and/or serious public impact due to a failure or defect of the products and/or malfunction attributed thereto.

- (1) Transportation equipment (automotive powertrain control system, train control system, and ship control system, etc.)
- (2) Traffic signal equipment
- (3) Disaster prevention equipment, crime prevention equipment
- (4) Medical devices classified as GHTF Class C (Japan Class III)
- (5) Highly public information network equipment, data-processing equipment (telephone exchange, and base station, etc.)
- (6) Any other equipment requiring high levels of quality and/or reliability equal to the equipment listed above

3. Equipment Prohibited for Use

Please do not incorporate our products into the following equipment requiring extremely high levels of safety and/or reliability.

- (1) Aerospace equipment (artificial satellite, rocket, etc.)
- (2) Aviation equipment *1
- (3) Medical devices classified as GHTF Class D (Japan Class IV), implantable medical devices *2
- (4) Power generation control equipment (nuclear power, hydroelectric power, thermal power plant control system, etc.)
- (5) Undersea equipment (submarine repeating equipment, etc.)
- (6) Military equipment
- (7) Any other equipment requiring extremely high levels of safety and/or reliability equal to the equipment listed above
- *Notes:1. There is a possibility that our products can be used only for aviation equipment that does not directly affect the safe operation of aircraft (e.g., in-flight entertainment, cabin light, electric seat, cooking equipment) if such use meets requirements specified separately by TAIYO YUDEN. Please be sure to contact TAIYO YUDEN for further information before using our products for such aviation equipment.
 - 2. Implantable medical devices contain not only internal unit which is implanted in a body, but also external unit which is connected to the internal unit.

4. Limitation of Liability

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this catalog for any equipment that is not intended for use by TAIYO YUDEN, or any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

Safety Design

When using our products for high safety and/or reliability-required equipment or circuits, please fully perform safety and/or reliability evaluation. In addition, please install (i) systems equipped with a protection circuit and a protection device and/or (ii) systems equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault for a failsafe design to ensure safety.

Intellectual Property Rights

Information contained in this catalog is intended to convey examples of typical performances and/or applications of our products and is not intended to make any warranty with respect to the intellectual property rights or any other related rights of TAIYO YUDEN or any third parties nor grant any license under such rights.

Limited Warranty

Please note that the scope of warranty for our products is limited to the delivered our products themselves conforming to the product specifications specified in the individual product specification sheets, and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a failure or defect in our products. Notwithstanding the foregoing, if there is a written agreement (e.g., supply and purchase agreement, quality assurance agreement) signed by TAIYO YUDEN and your company, TAIYO YUDEN will warrant our products in accordance with such agreement, provided, however, that our products shall be used for general-purpose and standard use in the equipment specified in this catalog or the individual product specification sheets.

■ TAIYO YUDEN's Official Sales Channel

The contents of this catalog are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this catalog are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.

Caution for Export

Some of our products listed in this catalog may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

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Industrial Application Guide

We have the product series (the 2nd code from the left side of the part number is "B") intended for use in telecommunications infrastructure and industrial equipment (its typical examples are as shown in the table below). Therefore, when using our products for these equipment, please check it carefully by referring to the part number or the individual product specification sheets and use the corresponding product series. Should you have any questions on this matter, please contact us.

Product Series (The 2nd Code from the Left Side of the Part Number)	Category	Telecommunications Infrastructure and Industrial Equipment (Typical Example)
В	Telecommunications Infrastructure	 Base Station Optical Transceiver Router/Switch (Carrier-Grade) UPS (Uninterruptible Power Supply), etc.
	Factory Automation	 PLC (Programmable Logic Controller) Servomotor/Servo Driver Industry Robot, etc.
	Measurement	 Gas Meter Water Meter Flow Meter Pressure Gauge Meter Magnetometer Thermometer, etc.
	Electric Power Apparatus	Power Conditioner (Solar Power System) Smart Meter GFCI (Ground Fault Circuit Interrupter) Electric Vehicle Charging Station, etc.

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Multilayer Ceramic Capacitors for Telecommunications Infrastructure and Industrial Equipment

REFLOW

■PART NUMBER

М	В	Α	S	Т	3	1	L	S	В	5	1	0	6	Κ	Т	N	Α	0	1
	C	<u> </u>		(2)	(;	3)	(4)	(5)		3)		(7)		(8)	9		(1	0	

1)Series

Code (1)(2)(3)(4)	
MBAS	Multilayer Ceramic Capacitor (High dielectric type) for Telecommunications Infrastructure and Industrial Equipment Multilayer Ceramic Capacitor (Temperature compensating type) for Telecommunications Infrastructure and Industrial Equipment Medium-High voltage Multilayer Ceramic Capacitor for Telecommunications Infrastructure and Industrial Equipment
MBAR	High frequency/Low loss Medium-High Voltage Multilayer Ceramic Capacitor for Telecommunications Infrastructure and Industrial Equipment
MBJC	Soft Termination Multilayer Ceramic Capacitor for Telecommunications Infrastructure and Industrial Equipment
MBRL	LW Reversal Decoupling Low ESL Capacitor (LWDC™) for Telecommunications Infrastructure and Industrial Equipment

(1) Product Group

Code	
М	Multilayer Ceramic Capacitor

(2) Category

<u> </u>		
Code	Recommended equipment	Quality Grade
В	Telecommunications Infrastructure and Industrial Equipment	2

(3) Type

Code	
Α	2 terminals
J	Soft Termination
R	LW reversal

(4) Features, Characteristics

(),	
Code	
S	Standard/General
R	High frequency/Low loss
С	Internal code (Soft Termination)
L	Low ESL

②Rated voltage

Code	Rated voltage[VDC]
Α	4
J	6.3
L	10
Е	16
Т	25
G	35
U	50
Н	100
Q	250
S	630

3Dimension (L × W)

@Bimension(E. W)							
Code	L×W [mm]	JIS(mm)	EIA(inch)				
06	0.6 × 0.3	0603	0201				
10	1.0 × 0.5	1005	0402				
10	0.52 × 1.0 💥	0510	0204				
16	1.6 × 0.8	1608	0603				
16	0.8 × 1.6 💥	0816	0306				
21	2.0 × 1.25	2012	0805				
21	1.25× 2.0 ※	1220	0508				
31	3.2 × 1.6	3216	1206				
32	3.2 × 2.5	3225	1210				
45	4.5 × 3.2	4532	1812				

Note: XLW reverse type (MBRL)

4)Thickness

THICKIESS	
Code	Thickness[mm]
3	0.3
5	0.5
7	0.7
8	0.8
9	0.85
Q	1.15
G	1.25
L	1.6
N	1.9 (0.088 max <u>※</u>)
М	2.5

Note: XLW reverse type(MBRL)

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.tv-top.com/).

⑤Dimension tolerance

Code	Dimension code	L[mm]	W[mm]	T[mm]	Thickness code
	10	1.0±0.10	0.5±0.10	0.5±0.10	5
	16	1.6+0.15/-0.05	0.8+0.15/-0.05	0.8+0.15/-0.05	8
	21	2.0+0.15/-0.05	1.25+0.15/-0.05	1.25+0.15/-0.05	G
Α	0.1	0.0.1.0.00	101000	1.15±0.20	Q
	31	3.2±0.20	1.6±0.20	1.6±0.20	L
	32	3.2±0.30	2.5±0.30	2.5±0.30	М
	10	1.0+0.15/-0.05	0.5+0.15/-0.05	0.5+0.15/-0.05	5
Б	16	1.6+0.20/-0	0.8+0.20/-0	0.8+0.20/-0	8
В	21	2.0+0.20/-0	1.25+0.20/-0	1.25+0.20/-0	G
	31	3.2±0.30	1.6±0.30	1.6±0.30	L
	10	1.0+0.20/-0	0.5+0.20/-0	0.5+0.20/-0	5
С	16	1.6+0.25/-0	0.8+0.25/-0	0.8+0.25/-0	8
	21	2.0+0.25/-0	1.25+0.25/-0	1.25+0.25/-0	G
D	21	2.0+0.30/-0	1.25+0.30/-0	1.25+0.30/-0	G
Н	31	3.2±0.15	1.6±0.15	1.15±0.10	Q
J	21	2.0+0.15/-0.05	1.25+0.15/-0.05	0.85±0.10	9
	21	2.0+0.20/-0	1.25+0.20/-0	0.85±0.10	9
L	32	3.2±0.50	2.5±0.30	2.5±0.30	М
N	21	2.0±0.15	1.25±0.15	0.85±0.15	9
	06	0.6±0.03	0.3±0.03	0.3±0.03	3
	10	1.0±0.05	0.5±0.05	0.5±0.05	5
	10	0.52±0.05 💥	1.0±0.05	0.3±0.05	3
		16+010	0.8±0.10	0.7±0.10	7
	16	1.6±0.10	0.8 ± 0.10	0.8±0.10	8
		0.8±0.10 ※	1.6±0.10	0.5±0.05	5
S		2.0±0.10	1,25±0,10	0.85±0.10	9
	21	2.0±0.10	1.25 ± 0.10	1.25±0.10	G
		1.25±0.15 💥	2.0±0.15	0.85±0.10	9
	31	3.2±0.15	1.6±0.15	1.6±0.20	L
	32	3.2±0.30	2.5±0.20	1.9±0.20	N
	32	3.2 ± 0.30	2.3 ± 0.20	2.5±0.20	М
	45	4.5±0.40	3.2±0.30	2.5±0.20	М

Note: XLW reverse type (MBRL)

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6Temperature characteristics code

■ High dielectric type

Code		cable idard	Temperature range[°C]	Ref. Temp. [°C] Capacitance change		Capacitance tolerance	Tolerance code
B5	EIA	X5R	-55~+ 85	25	±15%	±10%	K
	EIA	ASK	_55~ + 65	25	土13%	±20%	М
C6	EIA	X6S	-55~+105	25	±22%	±10%	K
	EIA	A03	-55~ +105	25	± 22 %	±20%	М
В7	EIA	X7R	-55~+125	25	±15%	±10%	K
B/	EIA	X/R	-55~+125		土13%	±20%	М
C7	EIA	X7S	-55~+125	25	±22%	±10%	K
	EIA	A/3	-55~ +125	25	± 22 %	±20%	М
D7	D7 EIA X7T −55~+125		25	+22%/-33%	±10%	K	
U/			-55~ +125	20	+ 22%/ - 33%	±20%	М

■Temperature compensating type

Code		cable idard	Temperature range[°C]	Ref. Temp.[°C]	Capacitance change	Capacitance tolerance	Tolerance code
						±0.05pF	Α
	JIS	CG		20		±0.1pF	В
CG			-55 ~ +125		0±30ppm/°C	±0.25pF	С
CG			-55~+125	25		±0.5pF	D
	EIA	C0G				±2%	G
						±5%	J
	JIS	СН		20	0±60ppm/°C	±0.25pF	С
CH	JIS	СП	$-55 \sim +125$	20		±0.5pF	D
	EIA	C0H		25		±5%	J
CJ	JIS	CJ	-55 ~ +125	20	0±120ppm/°C	±0.25pF	С
CJ	EIA	C0J	-55~ + 125	25	0±120ppm/ C	±0.25pF	
CK	JIS	CK	-55 ~ +125	20	0±250ppm/°C	±0.25pF	С
CK	EIA	C0K	-55~ + 125	25	0±250ppm/ C	±0.25pF	

7 Nominal capacitance

Code (example)	Nominal capacitance
0R5	0.5pF
010	1pF
100	10pF
101	100pF
102	1,000pF
103	0.01μF
104	0.1μF
105	1μF
106	10μF
107	100μF

Note: R=Decimal point

8 Capacitance tolerance

© Oupdoitailoc to	g dapaortando tolorando								
Code	Capacitance tolerance								
Α	±0.05pF								
В	±0.1pF								
С	±0.25pF								
D	±0.5pF								
G	±2%								
J	±5%								
K	±10%								
М	±20%								

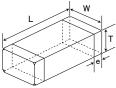
Packaging

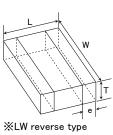
Code	Packaging							
F	ϕ 178mm Taping (2mm pitch)							
R	φ178mm Embossed Taping (4mm pitch)							
Т	ϕ 178mm Taping (4mm pitch)							
Р	φ178mm Taping (4mm pitch, 1000 pcs/reel) 3225 type(Thickness code M)							

10Internal code

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■STANDARD EXTERNAL DIMENSIONS





Tuma	JIS	EIA	Dimension [mm] (inch)								
Туре	(mm)	(inch)	L	W	Т	*1	е				
MBAS□06	0603	0201	0.6±0.03 (0.024±0.001)	0.3±0.03 (0.012±0.001)	0.3±0.03 (0.012±0.001)	3	0.15±0.05 (0.006±0.002)				
MBAR□10 MBAS□10	1005	0402	1.0±0.05 (0.039±0.002)	0.5 ± 0.05 (0.020 \pm 0.002)	0.5 ± 0.05 (0.020 \pm 0.002)	5	0.25±0.10 (0.010±0.004)				
MBRL□10 ※	0510	0204	0.52±0.05 (0.020±0.002)	1.0±0.05 (0.039±0.002)	0.3±0.05 (0.012±0.002)	3	0.18±0.08 (0.007±0.003)				
MBAS□16 MBAR□16	1608	0603	1.6±0.10 (0.063±0.004)	0.8±0.10 (0.031±0.004)	0.7±0.10 (0.028±0.004) 0.8±0.10	7	0.35±0.25 (0.014±0.010)				
MBJC□16	1608	0603	1.6±0.10 (0.063±0.004)	0.8±0.10 (0.031±0.004)	$\begin{array}{c} (0.031 \pm 0.004) \\ 0.8 \pm 0.10 \\ (0.031 \pm 0.004) \end{array}$	8	0.35+0.3/-0.25 (0.014+0.012/-0.010)				
MBRL□16 ※	0816	0306	0.8±0.10 (0.031±0.004)	1.6±0.10 (0.063±0.004)	0.5±0.05 (0.020±0.002)	5	0.25±0.15 (0.010±0.006)				
MBAS□21	2012	0805	2.0±0.10	1.25±0.10	0.85±0.10 (0.033±0.004)	9	0.5±0.25				
MBAR□21	2012	0803	(0.079±0.004)	(0.049 ± 0.004)	1.25±0.10 (0.049±0.004)	G	(0.020 ± 0.010)				
MD IOFI01	2012	0805	2.0±0.10	1.25±0.10	0.85±0.10 (0.033±0.004)	9	0.5+0.35/-0.25				
MBJC□21	2012	0805	(0.079 ± 0.004)	(0.049 ± 0.004)	1.25±0.10 (0.049±0.004)	G	(0.020 + 0.014 / -0.010)				
MBRL□21 ※	1220	0508	1.25±0.15 (0.049±0.006)	2.0±0.15 (0.079±0.006)	0.85±0.10 (0.033±0.004)	9	0.3±0.2 (0.012±0.008)				
MBAS□31	3216	1206	3.2±0.15 (0.126±0.006)	1.6±0.15 (0.063±0.006)	1.15±0.10 (0.045±0.004) 1.6±0.20	Q L	0.5+0.35/-0.25 (0.020+0.014/-0.010)				
	0010	1000	3.2±0.15	1.6±0.15	(0.063±0.008) 1.15±0.10 (0.045±0.004)	Q	0.6+0.4/-0.3				
MBJC□31	3216	1206	(0.126±0.006)	(0.063±0.006)	1.6±0.20 (0.063±0.008)	L	(0.024 + 0.016 / -0.012)				
MBAS□32	3225	1210	3.2±0.30	2.5±0.20	1.9±0.20 (0.075±0.008)	N	0.6±0.3				
			(0.126±0.012)	(0.098±0.008)	2.5±0.20 (0.098±0.008)	М	(0.024±0.012)				
MBJC□32	3225	1210	3.2±0.30	2.5±0.20	1.9±0.20 (0.075±0.008)	N	0.6+0.4/-0.3				
			(0.126±0.012)	(0.098±0.008)	2.5±0.20 (0.098±0.008)	М	(0.024+0.016/-0.012)				
MBAS□45	4532	1812	4.5±0.40 (0.177±0.016)	3.2±0.30 (0.126±0.012)	2.5±0.20 (0.098±0.008)	М	0.9±0.6 (0.035±0.024)				

Note: XLW reverse type (MBRL), *1. Thickness code

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■STANDARD QUANTITY

	Туре		Thick	ness	Standard quantity[pcs]		
Code	JIS(mm)	EIA(inch)	[mm]	Code	Paper tape	Embossed tape	
06	0603	0201	0.3 3		15000	_	
10	1005	0402	0.5	5	10000	_	
10	0510 💥	0204 💥	0.3	3	10000	_	
			0.7	7	4000	_	
	1608	0603	0.8	8	4000	_	
16	1008	0003	0.0	0	3000	3000	
			0.8	8	(Soft Termination)	(Soft Termination)	
	0816 💥	0306 💥	0.5	5	_	4000	
		0805	0.85	9	4000	_	
	2012		1.25	G	_	3000	
21	2012		1.25	0	_	2000	
			1.20	G	_	(Soft Termination)	
	1220 💥	0508 💥	0.85	9	4000	_	
31	2016	1006	1.15	Q	_	3000	
31	3216	1206	1.6	L	_	2000	
20	2005	1010	1.9	1.9 N		2000	
32	3225	1210	2.5	М	_	500(T), 1000(P)	
45	4532	1812	2.5	М	_	500	

Note: X.LW Reverse type (MBRL)

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High frequency/Low loss Medium-High Voltage Multilayer Ceramic Capacitors for Telecommunications Infrastructure and Industrial Equipment

■1005TYPF

[Temperature Characteristic CG : CG/C0G($-55 \sim +125 ^{\circ}$ C)] 0.5mm Thickness

New part number	Old part number (for reference)	Rated voltage [V]		erature eristics	Capacitance [F]	Capacitance tolerance	Q [at 1MHz] (Min)	HTLT Rated voltage x %	Thickness ^{*1} [mm]	Note
MBARQ105SCG0R5[FRA01	QVS105 CG0R5[]VHF		CG	COG	0.5 p	±0.1pF, ±0.25pF	810	200	0.5±0.05	
MBARQ105SCG0R6 FRA01	QVS105 CG0R6 VHF		CG	COG	0.6 p	±0.1pF, ±0.25pF	812	200	0.5 ± 0.05	
MBARQ105SCG0R7[FRA01	QVS105 CG0R7[]VHF		CG	COG	0.7 p	±0.1pF, ±0.25pF	814	200	0.5 ± 0.05	
MBARQ105SCGR75[FRA01	QVS105 CGR75[]VHF		CG	COG	0.75 p	±0.1pF, ±0.25pF	815	200	0.5 ± 0.05	
MBARQ105SCG0R8 FRA01	QVS105 CG0R8[]VHF		CG	COG	0.8 p	±0.1pF, ±0.25pF	816	200	0.5 ± 0.05	
MBARQ105SCG0R9[FRA01	QVS105 CG0R9[]VHF		CG	COG	0.9 p	±0.1pF, ±0.25pF	818	200	0.5 ± 0.05	
MBARQ105SCG010[FRA01	QVS105 CG010 VHF		CG	COG	1 p	±0.1pF, ±0.25pF	820	200	0.5 ± 0.05	
MBARQ105SCG1R1∏FRA01	QVS105 CG1R1 VHF		CG	COG	1.1 p	±0.1pF, ±0.25pF	822	200	0.5±0.05	
MBARQ105SCG1R2[FRA01	QVS105 CG1R2[]VHF		CG	COG	1.2 p	±0.1pF, ±0.25pF	824	200	0.5±0.05	
MBARQ105SCG1R3[FRA01	QVS105 CG1R3[]VHF		CG	COG	1.3 p	±0.1pF, ±0.25pF	826	200	0.5±0.05	
MBARQ105SCG1R5[FRA01	QVS105 CG1R5[]VHF		CG	COG	1.5 p	±0.1pF, ±0.25pF	830	200	0.5±0.05	
MBARQ105SCG1R6[FRA01	QVS105 CG1R6[]VHF		CG	COG	1.6 p	±0.1pF, ±0.25pF	832	200	0.5±0.05	
MBARQ105SCG1R8[FRA01	QVS105 CG1R8[]VHF]	CG	COG	1.8 p	±0.1pF, ±0.25pF	836	200	0.5±0.05	
MBARQ105SCG020[FRA01	QVS105 CG020 VHF		CG	COG	2 p	±0.1pF, ±0.25pF	840	200	0.5±0.05	
MBARQ105SCG2R2[FRA01	QVS105 CG2R2[]VHF]	CG	COG	2.2 p	±0.1pF, ±0.25pF	844	200	0.5±0.05	
MBARQ105SCG2R4[FRA01	QVS105 CG2R4[]VHF		CG	COG	2.4 p	±0.1pF, ±0.25pF	848	200	0.5±0.05	
MBARQ105SCG2R7[FRA01	QVS105 CG2R7∏VHF		CG	COG	2.7 p	±0.1pF, ±0.25pF	854	200	0.5±0.05	
MBARQ105SCG030[FRA01	QVS105 CG030 VHF		CG	COG	3 р	±0.1pF, ±0.25pF	860	200	0.5±0.05	
MBARQ105SCG3R3[FRA01	QVS105 CG3R3∏VHF		CG	COG	3.3 p	±0.1pF, ±0.25pF	866	200	0.5±0.05	
MBARQ105SCG3R6 FRA01	QVS105 CG3R6∏VHF		CG	COG	3.6 p	±0.1pF, ±0.25pF	872	200	0.5±0.05	
MBARQ105SCG3R9[FRA01	QVS105 CG3R9[]VHF		CG	COG	3.9 p	±0.1pF, ±0.25pF	878	200	0.5±0.05	
MBARQ105SCG4R3[FRA01	QVS105 CG4R3[]VHF	250	CG	COG	4.3 p	±0.1pF, ±0.25pF	886	200	0.5±0.05	
MBARQ105SCG4R7[FRA01	QVS105 CG4R7[]VHF		CG	COG	4.7 p	±0.1pF, ±0.25pF	894	200	0.5±0.05	
MBARQ105SCG5R1[FRA01	QVS105 CG5R1[]VHF		CG	COG	5.1 p	±0.25pF, ±0.5pF	902	200	0.5±0.05	
MBARQ105SCG5R6 FRA01	QVS105 CG5R6∏VHF		CG	COG	5.6 p	±0.25pF, ±0.5pF	912	200	0.5±0.05	
MBARQ105SCG6R2 FRA01	QVS105 CG6R2∏VHF		CG	COG	6.2 p	±0.25pF, ±0.5pF	924	200	0.5±0.05	
MBARQ105SCG6R8 FRA01	QVS105 CG6R8∏VHF		CG	COG	6.8 p	±0.25pF, ±0.5pF	936	200	0.5±0.05	
MBARQ105SCG7R5 FRA01	QVS105 CG7R5∏VHF		CG	COG	7.5 p	±0.25pF, ±0.5pF	950	200	0.5±0.05	
MBARQ105SCG8R2[FRA01	QVS105 CG8R2[]VHF		CG	COG	8.2 p	±0.25pF, ±0.5pF	964	200	0.5±0.05	
MBARQ105SCG9R1 FRA01	QVS105 CG9R1∏VHF		CG	COG	9.1 p	±0.25pF, ±0.5pF	982	200	0.5±0.05	
MBARQ105SCG100JFRA01	QVS105 CG100JVHF		CG	COG	10 p	±5%	1000	200	0.5±0.05	
MBARQ105SCG110JFRA01	QVS105 CG110JVHF		CG	COG	11 p	±5%	1020	200	0.5±0.05	
MBARQ105SCG120JFRA01	QVS105 CG120JVHF		CG	COG	12 p	±5%	1040	200	0.5±0.05	
MBARQ105SCG130JFRA01	QVS105 CG130JVHF		CG	COG	13 p	±5%	1060	200	0.5±0.05	
MBARQ105SCG150JFRA01	QVS105 CG150JVHF		CG	COG	15 p	±5%	1100	200	0.5±0.05	
MBARQ105SCG160JFRA01	QVS105 CG160JVHF	1	CG	COG	16 p	±5%	1120	200	0.5±0.05	
MBARQ105SCG180JFRA01	QVS105 CG180JVHF	1	CG	COG	18 p	±5%	1160	200	0.5±0.05	
MBARQ105SCG200JFRA01	QVS105 CG200JVHF	1 1	CG	COG	20 p	±5%	1200	200	0.5±0.05	
	QVS105 CG220JVHF	1 1	CG	COG	22 p	±5%	1240	200	0.5±0.05	
MBARQ105SCG240JFRA01	QVS105 CG240JVHF	1 1	CG	COG	24 p	±5%	1280	200	0.5±0.05	
	QVS105 CG270JVHF	1 1	CG	COG	27 p	±5%	1340	200	0.5±0.05	
	QVS105 CG300JVHF	1 1	CG	COG	30 p	±5%	1400	200	0.5±0.05	
	QVS105 CG330JVHF	1	CG	COG	33 p	±5%	1400	200	0.5±0.05	

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PART NUMBER

●1608TYPE

[Temperature Characteristic CG : CG/C0G($-55 \sim +125 ^{\circ}$ C)] 0.7mm Thickness

Temperature onaract	Old part number	Rated voltage	Tempe		Capacitance	0 %	Q	HTLT	*1 = 3	
New part number	(for reference)	[V]		eristics	[F]	Capacitance tolerance	[at 1MHz] (Min)	Rated voltage x %	Thickness*1 [mm]	Note
MBARQ167SCG0R2[]TRA01	QVS107 CG0R2[]CHT		CG	C0G	0.2 p	±0.05pF, ±0.1pF	804	200	0.7±0.10	
MBARQ167SCG0R3[TRA01	QVS107 CG0R3[]CHT		CG	COG	0.3 p	±0.05pF, ±0.1pF	806	200	0.7±0.10	
MBARQ167SCG0R4[]TRA01	QVS107 CG0R4[]CHT]	CG	C0G	0.4 p	$\pm 0.05 pF, \pm 0.1 pF$	808	200	0.7±0.10	
MBARQ167SCG0R5[TRA01	QVS107 CG0R5[]CHT]	CG	COG	0.5 p	±0.1pF, ±0.25pF	810	200	0.7±0.10	
MBARQ167SCG0R6[]TRA01	QVS107 CG0R6[CHT		CG	C0G	0.6 p	$\pm 0.1 pF$, $\pm 0.25 pF$	812	200	0.7±0.10	
MBARQ167SCG0R7 TRA01	QVS107 CG0R7[CHT		CG	COG	0.7 p	$\pm 0.1 pF, \pm 0.25 pF$	814	200	0.7±0.10	
MBARQ167SCGR75 TRA01	QVS107 CGR75 CHT		CG	COG	0.75 p	±0.1pF, ±0.25pF	815	200	0.7±0.10	
MBARQ167SCG0R8 TRA01	QVS107 CG0R8 CHT		CG	COG	0.8 p	±0.1pF, ±0.25pF	816	200	0.7±0.10	
MBARQ167SCG0R9 TRA01	QVS107 CG0R9[CHT		CG	COG	0.9 p	±0.1pF, ±0.25pF	818	200	0.7±0.10	
MBARQ167SCG010[]TRA01	QVS107 CG010 CHT		CG	COG	1 p	±0.1pF, ±0.25pF	820	200	0.7±0.10	
MBARQ167SCG1R1 TRA01	QVS107 CG1R1 CHT		CG	COG	1.1 p	±0.1pF, ±0.25pF	822	200	0.7±0.10	
MBARQ167SCG1R2 TRA01	QVS107 CG1R2 CHT		CG CG	COG	1.2 p	±0.1pF, ±0.25pF	824	200 200	0.7±0.10 0.7±0.10	
MBARQ167SCG1R3[TRA01	QVS107 CG1R3 CHT			COG	1.3 p	±0.1pF, ±0.25pF	826 830			
MBARQ167SCG1R5[]TRA01	QVS107 CG1R5 CHT	-	CG	C0G C0G	1.5 p	±0.1pF, ±0.25pF	830	200 200	0.7±0.10	
MBARQ167SCG1R6☐TRA01 MBARQ167SCG1R8∏TRA01	QVS107 CG1R6 CHT QVS107 CG1R8 CHT	 	CG	COG	1.6 p	±0.1pF, ±0.25pF ±0.1pF, ±0.25pF	836	200	0.7±0.10 0.7±0.10	
MBARQ167SCG020[TRA01	QVS107 CG1R6[]CHT	1	CG	COG	2 p	±0.1pF, ±0.25pF	840	200	0.7±0.10	
MBARQ167SCG020[]TRA01	QVS107 CG020[]CHT	1	CG	COG	2.2 p	±0.1pF, ±0.25pF ±0.1pF, ±0.25pF	844	200	0.7±0.10 0.7±0.10	
MBARQ167SCG2R4[TRA01	QVS107 CG2R2[]CHT	 	CG	COG	2.2 p 2.4 p	±0.1pF, ±0.25pF	848	200	0.7±0.10 0.7±0.10	
MBARQ167SCG2R7 TRA01	QVS107 CG2R7[]CHT	1	CG	COG	2.4 p	±0.1pF, ±0.25pF	854	200	0.7±0.10	
MBARQ167SCG030[TRA01	QVS107 CG030 CHT		CG	COG	3 p	±0.1pF, ±0.25pF	860	200	0.7±0.10	
MBARQ167SCG3R3 TRA01	QVS107 CG3R3∏CHT		CG	COG	3.3 p	±0.1pF, ±0.25pF	866	200	0.7±0.10	·
MBARQ167SCG3R6 TRA01	QVS107 CG3R6 CHT		CG	COG	3.6 p	±0.1pF, ±0.25pF	872	200	0.7±0.10	·
MBARQ167SCG3R9 TRA01	QVS107 CG3R9[]CHT	1	CG	COG	3.9 p	±0.1pF, ±0.25pF	878	200	0.7±0.10	
MBARQ167SCG4R3 TRA01	QVS107 CG4R3 CHT	1	CG	COG	4.3 p	±0.1pF, ±0.25pF	886	200	0.7±0.10	
MBARQ167SCG4R7 TRA01	QVS107 CG4R7 CHT	1	CG	COG	4.7 p	±0.1pF, ±0.25pF	894	200	0.7±0.10	
MBARQ167SCG5R1 TRA01	QVS107 CG5R1 CHT	1	CG	COG	5.1 p	±0.25pF,±0.5pF	902	200	0.7±0.10	
MBARQ167SCG5R6 TRA01	QVS107 CG5R6[]CHT		CG	COG	5.6 p	±0.25pF,±0.5pF	912	200	0.7±0.10	
MBARQ167SCG6R2 TRA01	QVS107 CG6R2[CHT	050	CG	COG	6.2 p	±0.25pF,±0.5pF	924	200	0.7±0.10	
MBARQ167SCG6R8[TRA01	QVS107 CG6R8[CHT	250	CG	COG	6.8 p	±0.25pF,±0.5pF	936	200	0.7±0.10	
MBARQ167SCG7R5[TRA01	QVS107 CG7R5[]CHT		CG	COG	7.5 p	±0.25pF,±0.5pF	950	200	0.7±0.10	
MBARQ167SCG8R2[TRA01	QVS107 CG8R2[]CHT]	CG	COG	8.2 p	$\pm 0.25 pF, \pm 0.5 pF$	964	200	0.7±0.10	
MBARQ167SCG9R1 TRA01	QVS107 CG9R1 CHT		CG	COG	9.1 p	$\pm 0.25 pF, \pm 0.5 pF$	982	200	0.7±0.10	
MBARQ167SCG100[TRA01	QVS107 CG100[]CHT		CG	COG	10 p	±2%, ±5%	1000	200	0.7 ± 0.10	
MBARQ167SCG110JTRA01	QVS107 CG110JCHT		CG	COG	11 p	±5%	1020	200	0.7±0.10	
MBARQ167SCG120JTRA01	QVS107 CG120JCHT		CG	COG	12 p	±5%	1040	200	0.7±0.10	
MBARQ167SCG130JTRA01	QVS107 CG130JCHT]	CG	C0G	13 p	±5%	1060	200	0.7±0.10	
MBARQ167SCG150JTRA01	QVS107 CG150JCHT		CG	COG	15 p	±5%	1100	200	0.7±0.10	
MBARQ167SCG160JTRA01	QVS107 CG160JCHT		CG	COG	16 p	±5%	1120	200	0.7±0.10	
MBARQ167SCG180JTRA01	QVS107 CG180JCHT		CG	COG	18 p	±5%	1160	200	0.7±0.10	
MBARQ167SCG200JTRA01	QVS107 CG200JCHT		CG	COG	20 p	±5%	1200	200	0.7±0.10	
MBARQ167SCG220JTRA01	QVS107 CG220JCHT		CG	COG	22 p	±5%	1240	200	0.7±0.10	
MBARQ167SCG240JTRA01	QVS107 CG240JCHT	 	CG	COG	24 p	±5%	1280	200	0.7±0.10	
MBARQ167SCG270JTRA01	QVS107 CG270JCHT		CG	COG	27 p	±5%	1340	200	0.7±0.10	
MBARQ167SCG300JTRA01	QVS107 CG300JCHT	 	CG	COG	30 p	±5%	1400	200	0.7±0.10	
MBARQ167SCG330JTRA01	QVS107 CG330JCHT	 	CG	COG	33 p	±5%	1400 1400	200	0.7±0.10	
MBARQ167SCG360JTRA01	QVS107 CG360JCHT	 	CG	COG	36 p	±5%		200	0.7±0.10	
MBARQ167SCG390JTRA01 MBARQ167SCG430JTRA01	QVS107 CG390JCHT QVS107 CG430JCHT	{	CG	C0G C0G	39 p 43 p	±5% ±5%	1400 1400	200 200	0.7±0.10 0.7±0.10	
MBARQ167SCG430JTRA01	QVS107 CG430JCHT	 	CG	COG	43 p 47 p	±5%	1400	200	0.7±0.10 0.7±0.10	
MBARQ167SCG510JTRA01	QVS107 CG4703CHT	 	CG	COG	47 p 51 p	±5%	1400	200	0.7±0.10	
MBARQ167SCG560JTRA01	QVS107 CG510JCHT	1	CG	COG	56 p	±5%	1400	200	0.7±0.10 0.7±0.10	
MBARQ167SCG5600TRA01	QVS107 CG560JCHT	 	CG	COG	62 p	±5%	1400	200	0.7±0.10 0.7±0.10	
MBARQ167SCG620JTRA01	QVS107 CG620JCHT	1	CG	COG	68 p	±5%	1400	200	0.7±0.10 0.7±0.10	
MBARQ167SCG750JTRA01	QVS107 CG0800CHT	 	CG	COG	75 p	±5%	1400	200	0.7±0.10 0.7±0.10	
MBARQ167SCG820JTRA01	QVS107 CG820JCHT	1 1	CG	COG	82 p	±5%	1400	200	0.7±0.10	
MBARQ167SCG910JTRA01	QVS107 CG910JCHT	1	CG	COG	91 p	±5%	1400	200	0.7±0.10	
MBARQ167SCG101JTRA01	QVS107 CG101JCHT	1	CG	COG	100 p	±5%	1400	200	0.7±0.10	
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PART NUMBER

2012TYPE

[Temperature Characteristic CG : CG/C0G($-55 \sim +125 ^{\circ}$ C)] 0.85mm Thickness

	Old part number	Rated voltage	Tompo	rature	Capacitance		Q	HTLT		
New part number	(for reference)	[V]		eristics	[F]	Capacitance tolerance	[at 1MHz]	Rated voltage x %	Thickness*1 [mm]	Note
							(Min)			
MBARQ219SCG0R3 TRA01	QVS212 CG0R3[]DHT	4	CG	COG	0.3 p	±0.1pF, ±0.25pF,±0.5pF	806	200	0.85±0.10	
MBARQ219SCG0R4[TRA01	QVS212 CG0R4 DHT	4	CG	COG	0.4 p	±0.1pF, ±0.25pF,±0.5pF	808	200	0.85±0.10	
MBARQ219SCG0R5[TRA01	QVS212 CG0R5[]DHT	4	CG	COG	0.5 p	±0.1pF, ±0.25pF	810	200	0.85±0.10	
MBARQ219SCG0R6 TRA01	QVS212 CG0R6[]DHT	4	CG	COG	0.6 p	±0.1pF, ±0.25pF	812	200	0.85±0.10	
MBARQ219SCG0R7 TRA01	QVS212 CG0R7[]DHT	4	CG	COG	0.7 p	±0.1pF, ±0.25pF	814	200	0.85±0.10	
MBARQ219SCGR75 TRA01	QVS212 CGR75[]DHT	4	CG	COG	0.75 p	±0.1pF, ±0.25pF	815	200	0.85±0.10	
MBARQ219SCG0R8 TRA01	QVS212 CG0R8[]DHT	4	CG	COG	0.8 p	±0.1pF, ±0.25pF	816	200	0.85±0.10	
MBARQ219SCG0R9[TRA01	QVS212 CG0R9[]DHT	4	CG	COG	0.9 p	±0.1pF, ±0.25pF	818	200	0.85±0.10	
MBARQ219SCG010[TRA01	QVS212 CG010 DHT	4	CG	COG	1 p	±0.1pF, ±0.25pF	820	200	0.85±0.10	
MBARQ219SCG1R1 TRA01	QVS212 CG1R1[]DHT	4	CG	COG	1.1 p	±0.1pF, ±0.25pF	822	200	0.85±0.10	
MBARQ219SCG1R2[TRA01	QVS212 CG1R2[]DHT	-	CG	COG	1.2 p	±0.1pF, ±0.25pF	824	200 200	0.85±0.10	
MBARQ219SCG1R3[TRA01	QVS212 CG1R3[]DHT	4	CG	COG	1.3 p	±0.1pF, ±0.25pF	826		0.85±0.10	
MBARQ219SCG1R5 TRA01	QVS212 CG1R5[]DHT	4	CG	COG	1.5 p	±0.1pF, ±0.25pF	830	200	0.85±0.10	
MBARQ219SCG1R6 TRA01	QVS212 CG1R6[]DHT	4	CG	COG	1.6 p	±0.1pF, ±0.25pF	832	200	0.85±0.10	
MBARQ219SCG1R8[TRA01	QVS212 CG1R8[]DHT	-	CG	COG	1.8 p	±0.1pF, ±0.25pF	836	200	0.85±0.10	
MBARQ219SCG020[TRA01	QVS212 CG020 DHT	4	CG	COG	2 p	±0.1pF, ±0.25pF	840	200	0.85±0.10	
MBARQ219SCG2R2[]TRA01	QVS212 CG2R2[]DHT	-	CG	COG	2.2 p	±0.1pF, ±0.25pF	844	200	0.85±0.10	
MBARQ219SCG2R4[]TRA01	QVS212 CG2R4[]DHT	4	CG	COG	2.4 p	±0.1pF, ±0.25pF	848	200	0.85±0.10	
MBARQ219SCG2R7[]TRA01	QVS212 CG2R7[]DHT	-	CG	COG	2.7 p	±0.1pF, ±0.25pF	854 860	200	0.85±0.10	
MBARQ219SCG030[]TRA01	QVS212 CG030 DHT	-	CG	C0G C0G	3 p	±0.1pF, ±0.25pF	866	200 200	0.85±0.10	
MBARQ219SCG3R3[TRA01	QVS212 CG3R3[]DHT	-			3.3 p	±0.1pF, ±0.25pF			0.85±0.10	
MBARQ219SCG3R6[TRA01	QVS212 CG3R6[]DHT	4	CG	C0G C0G	3.6 p	±0.1pF, ±0.25pF	872 878	200	0.85±0.10	
MBARQ219SCG3R9[TRA01	QVS212 CG3R9[]DHT	-	CG	COG	3.9 p 4.3 p	±0.1pF, ±0.25pF	886	200 200	0.85±0.10 0.85±0.10	
MBARQ219SCG4R3[TRA01 MBARQ219SCG4R7[TRA01	QVS212 CG4R3[]DHT QVS212 CG4R7[]DHT	-	CG	COG	4.3 p	±0.1pF, ±0.25pF ±0.1pF, ±0.25pF	894	200	0.85±0.10	
MBARQ219SCG4R7∐TRA01	QVS212 CG4R7[]DHT	-	CG	COG	4.7 p 5.1 p	±0.1pr, ±0.25pr ±0.25pF, ±0.5pF	902	200	0.85±0.10	
MBARQ219SCG5R6 TRA01	QVS212 CG5R1[]DHT	-	CG	COG	5.6 p	±0.25pF, ±0.5pF ±0.25pF, ±0.5pF	912	200	0.85±0.10	
MBARQ219SCG6R2[TRA01	QVS212 CG5R0[]DHT	-	CG	COG	6.2 p	±0.25pF, ±0.5pF	924	200	0.85±0.10	
MBARQ219SCG6R8 TRA01	QVS212 CG6R8[]DHT	250	CG	COG	6.8 p	±0.25pF, ±0.5pF	936	200	0.85±0.10	
MBARQ219SCG7R5 TRA01	QVS212 CG7R5[]DHT	200	CG	COG	7.5 p	±0.25pF, ±0.5pF	950	200	0.85±0.10	
MBARQ219SCG8R2 TRA01	QVS212 CG8R2[]DHT	1	CG	COG	8.2 p	±0.25pF, ±0.5pF	964	200	0.85±0.10	
MBARQ219SCG9R1 TRA01	QVS212 CG9R1[]DHT	1	CG	COG	9.1 p	±0.25pF, ±0.5pF	982	200	0.85±0.10	
MBARQ219SCG100JTRA01	QVS212 CG100JDHT	1	CG	COG	10 p	±5%	1000	200	0.85±0.10	
MBARQ219SCG110JTRA01	QVS212 CG110JDHT	1	CG	COG	11 p	±5%	1020	200	0.85±0.10	
MBARQ219SCG120JTRA01	QVS212 CG120JDHT	1	CG	COG	12 p	±5%	1040	200	0.85±0.10	
MBARQ219SCG130JTRA01	QVS212 CG130JDHT	1	CG	COG	13 p	±5%	1060	200	0.85±0.10	
MBARQ219SCG150JTRA01	QVS212 CG150JDHT	1	CG	COG	15 p	±5%	1100	200	0.85±0.10	
MBARQ219SCG160JTRA01	QVS212 CG160JDHT	1	CG	COG	16 p	±5%	1120	200	0.85±0.10	
MBARQ219SCG180JTRA01	QVS212 CG180JDHT	1	CG	COG	18 p	±5%	1160	200	0.85±0.10	
MBARQ219SCG200JTRA01	QVS212 CG200JDHT	1	CG	COG	20 p	±5%	1200	200	0.85±0.10	
MBARQ219SCG220JTRA01	QVS212 CG220JDHT	1	CG	COG	22 p	±5%	1240	200	0.85±0.10	
MBARQ219SCG240JTRA01	QVS212 CG240JDHT	1	CG	COG	24 p	±5%	1280	200	0.85±0.10	
MBARQ219SCG270JTRA01	QVS212 CG270JDHT	1	CG	COG	27 p	±5%	1340	200	0.85±0.10	
MBARQ219SCG300JTRA01	QVS212 CG300JDHT	1	CG	COG	30 p	±5%	1400	200	0.85±0.10	
MBARQ219SCG330JTRA01	QVS212 CG330JDHT	1	CG	COG	33 p	±5%	1400	200	0.85±0.10	
MBARQ219SCG360JTRA01	QVS212 CG360JDHT	1	CG	COG	36 p	±5%	1400	200	0.85±0.10	
MBARQ219SCG390JTRA01	QVS212 CG390JDHT	1	CG	COG	39 p	±5%	1400	200	0.85±0.10	
MBARQ219SCG430JTRA01	QVS212 CG430JDHT	1 1	CG	COG	43 p	±5%	1400	200	0.85±0.10	
MBARQ219SCG470JTRA01	QVS212 CG470JDHT	1	CG	COG	47 p	±5%	1400	200	0.85±0.10	
MBARQ219SCG510JTRA01	QVS212 CG510JDHT	1 1	CG	COG	51 p	±5%	1400	200	0.85±0.10	
MBARQ219SCG560JTRA01	QVS212 CG560JDHT	1 l	CG	COG	56 p	±5%	1400	200	0.85±0.10	
MBARQ219SCG620JTRA01	QVS212 CG620JDHT	1 1	CG	COG	62 p	±5%	1400	200	0.85±0.10	
MBARQ219SCG680JTRA01	QVS212 CG680JDHT	1	CG	COG	68 p	±5%	1400	200	0.85±0.10	
MBARQ219SCG750JTRA01	QVS212 CG750JDHT	1 1	CG	COG	75 p	±5%	1400	200	0.85±0.10	
MBARQ219SCG820JTRA01	QVS212 CG820JDHT	1	CG	COG	82 p	±5%	1400	200	0.85±0.10	
MBARQ219SCG910JTRA01	QVS212 CG910JDHT	1 1	CG	COG	91 p	±5%	1400	200	0.85±0.10	
MBARQ219SCG101JTRA01	QVS212 CG101JDHT	1 1	CG	COG	100 p	±5%	1400	200	0.85±0.10	
					р			200	3.00=0.10	

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PACKAGING

①Minimum Quantity

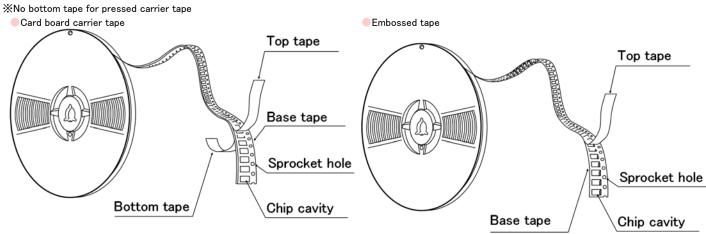
Taped package

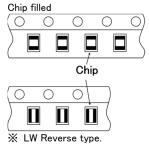
	Туре		Thick	ness	Standard Q	Standard Quantity[pcs]		
Code	JIS(mm)	EIA(inch)	[mm]	Code	Paper tape	Embossed tape		
02	0201	008004	0.125	1	_	50000		
04	0402	01005	0.2	2	_	40000		
06	0603	0201	0.3	3	15000	_		
			0.13	Н	_	20000		
41	1005	0400	0.18	E	_	15000		
1L	1005	0402	0.2	2	20000	_		
			0.3	3	15000	_		
10	1005	0402	0.5	5	10000	_		
10	0510 💥	0204	0.3	3	10000	_		
		0.45	K					
			0.7	7	4000	_		
1608	0603	0.8	8					
10	10		0.8	8	3000	3000		
			0.8	8	(Soft Termination)	(Soft Termination		
	0816 💥	0306	0.5	5	_	4000		
		0805	0.85	9	4000	_		
	2012		1.25	G	_	3000		
21	2012	0000	1.25	G	_	2000 (Soft Termination		
	1220 💥	0508	0.85	9	4000	_		
			0.85	9	4000	_		
31	3216	1206	1.15	Q	_	3000		
			1.6	L	_	2000		
			0.85	9				
			1.15	Q		2000		
32	3225	1210	1.9	N	_	2000		
		[2.0 max	Υ				
			2.5	М	_	500(T), 1000(P		
45	4522	1010	2.0 max	Υ	_	1000		
40	4532	1812	2.5	М	_	500		

注:※LW Reverse type(MSRL, MCRL, MBRL, MLRL, MMRL)

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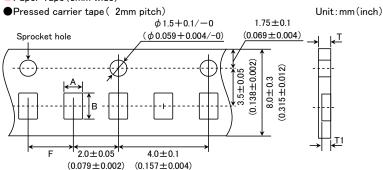
2Taping material





3 Representative taping dimensions

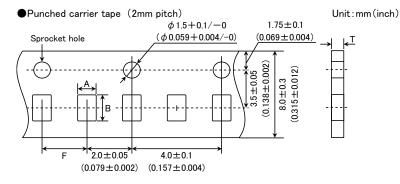
Paper Tape (8mm wide)



Type(EIA)	Chip	Cavity	Insertion Pitch	Tape Thickness		
	Α	В	F	Т	T1	
0603 (0201)	0.37	0.67		0.45	0.40	
0510 (0204) 💥			2.0±0.05	0.45max.	0.42max.	
1005 (0402) (*1 2)	0.65	1.15	2.0±0.05	0.4max.	0.3max.	
1005 (0402) (*1 3)				0.45max.	0.42max.	

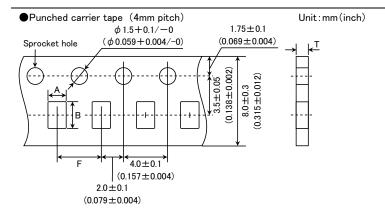
Note *1 Thickness, 2:0.2mm , 3:0.3mm. $\mbox{\ensuremath{\mbox{$\times$}}}$ LW Reverse type.

Unit: mm



Type(EIA)	Chip (Cavity	Insertion Pitch	Tape Thickness
Type(EIA)	Α	В	F	Т
1005 (0402)	0.65	1.15	2.0±0.05	0.8max.
				Unit:mm

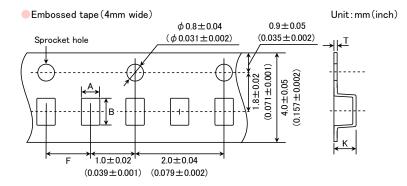
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Type(EIA)	Chip Cavity		Insertion Pitch	Tape Thickness
Type(EIA)	Α	В	F	Т
1608 (0603) 0816 (0306) ※	1.0	1.8		1.1max.
2012 (0805) 1220 (0508) ※	1.65	2.4	4.0±0.1	1.1max.
3216 (1206)	2.0	3.6		

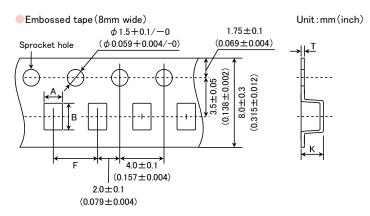
Note: Taping size might be different depending on the size of the product. 💥 LW Reverse type.

Unit:mm



Type(EIA)	Chip Cavity		Insertion Pitch	Tape Thickness	
Type(EIA)	Α	В	F	K	Т
0201 (008004)	0.135	0.27	1.0±0.02	0.5max.	0.25max.
0402 (01005)	0.23	0.43	1.0 ± 0.02	u.amax.	0.25max.
					11.5

Unit:mm



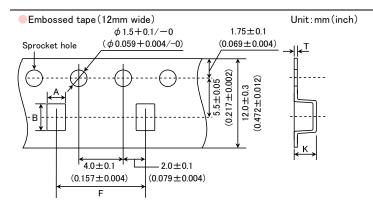
Τ (ΓΙΔ)	Chip Cavity		Insertion Pitch	Tape Thickness	
Type(EIA)	Α	В	F	K	Т
1005 (0402)	0.6	1.1	2.0±0.1	0.6max	0.2±0.1
0816 (0306) 💥	1.0	1.8		1.3max.	0.25±0.1
2012 (0805)	1.65	2.4	40101		
3216 (1206)	2.0	3.6	4.0±0.1	3.4max.	0.6max.
3225 (1210)	2.8	3.6			

Note:

LW Reverse type.

Unit:mm

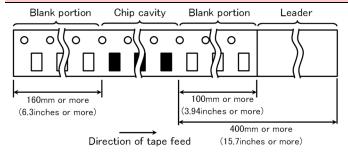
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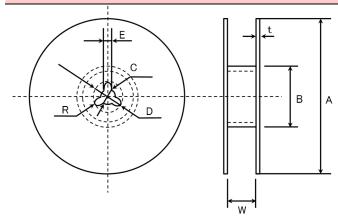
Type(EIA)	Chip (Cavity	Insertion Pitch	Tape Th	nickness
Type(EIA)	Α	В	F	K	Т
3225 (1210)	3.1	4.0	8.0±0.1	4.0max.	0.6max.
4532 (1812)	3.7	4.9	8.0±0.1	4.0max.	0.6max.

Unit:mm

4 Trailer and Leader



5Reel size



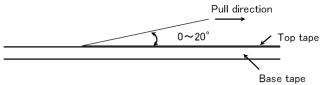
Α	В	С	D	E	R
ϕ 178±2.0	<i>ф</i> 50min.	ϕ 13.0 \pm 0.2	ϕ 21.0 ± 0.8	2.0±0.5	1.0

	Т	W
4mm wide tape	1.5max.	5±1.0
8mm wide tape	2.5max.	10±1.5
12mm wide tape	2.5max.	14±1.5

Unit:mm

⑥Top Tape Strength

The top tape requires a peel-off force of 0.1 to 0.7N in the direction of the arrow as illustrated below.



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Medium-High Voltage Multilayer Ceramic Capacitor

for Telecommunications Infrastructure and Industrial Equipment

High frequency/Low loss Medium-High Voltage Multilayer Ceramic Capacitor

for Telecommunications Infrastructure and Industrial Equipment

Medium-High Voltage Multilayer Ceramic Capacitor

for Medical Devices classified as GHTF Class C (Japan Class III)

High frequency/Low loss Medium-High Voltage Multilayer Ceramic Capacitor

for Medical Devices classified as GHTF Class C (Japan Class III)

■RELIABILITY DATA

	Temperature Compensating (High Frequency type) CG(C0G) : −55 to +125°C	
Specified Value		
	High permittivity	
	X7R, X7S : −55 to +125°C	

2. Storage Tempera	ature Range
Specified Value	Temperature Compensating (High Frequency type) CG(C0G) : -55 to +125°C
	High permittivity X7R, X7S : -55 to +125°C

3. Rated Voltage	
Specified Value	100VDC(Code:H), 250VDC(Code:Q), 630VDC(Code:S)

4. Withstanding Vo	4. Withstanding Voltage (Between terminals)				
Specified Value	No breakdown or damage				
Test Methods and Remarks	Applied voltage Duration Carge/discharge current	: Rated voltage(H) \times 2.5, Rated voltage(Q) \times 2, Rated voltage(S) \times 1.2 : 1 to 5sec. : 50mA max.			

5. Insulation Resis	tance			
	Temperature Compensating $10000M\Omega$ min	(High Frequency type)		
Specified Value				
	High permittivity $100M\Omega \mu F$ or $10G\Omega$, whichever is smaller.			
	Applied voltage	: Rated voltage(H, Q), 500V(S)		
Test Methods	Duration	: 60±5sec.		
and Remarks	Charge/discharge current	: 50mA max.		

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Specified Value	Temperature Compensat $C < 0.5pF(\pm 0.05pF \text{ or } \pm 0.5pF \le C < 5pF(\pm 0.1pF 5pF \le C < 10(\pm 0.25pF \text{ or } C \ge 10pF(\pm 5\%) $	0.1pF), or ±0.25pF) ±0.5pF)	
	High permittivity ±10%, ±20%		
	Temperature Compensat		
	Measuring frequency	: 1MHz±10%	
	5 5	: 0.5 to 5Vrms	
Test Methods	Bias application	: None	
and Remarks	High permittivity		
	Measuring frequency	: 1kHz±10%	
	Measuring voltage	: 1±0.2Vrms	
	Bias application	: None	

7. Q or Dissipation	n Factor	
		ating (High Frequency type)
	C<30pF: Q≧800+20	С
	C≧30pF: Q≧1400	(C: Normal Capacitance)
Specified Value		
	High permittivity	
	3.5%max(H)	
	2.5%max(Q, S)	
	Temperature Compensa	ating (High Frequency type)
	Measuring frequency	: 1MHz±10%
	Measuring voltage	: 0.5 to 5Vrms
Test Methods	Bas application	: None
and Remarks		
and nomarks	High permittivity	
	Measuring frequency	: 1kHz±10%
	Measuring voltage	: 1±0.2Vrms
	Bas application	: None

8. Temperature Ch	naracteristic of Capacitance			
Specified Value	Temperature Compensating (High Frequency type) $CG(C0G) : 0 \pm 30 \text{ppm} (-55 \text{ to } +125^{\circ}\text{C})$ High permittivity			
	X7R : $\pm 15\%(-55 \text{ to } +125\%C)$ X7S : $\pm 22\%(-55 \text{ to } +125\%C)$			
Test Methods	Temperature Compensating (High Frequency type) Capacitance at 25° C and 85° C shall be measured in thermal equilibrium, and the temperature characteristic shall be calculated from the following equation. $\frac{(C_{85}-C_{25})}{C_{25}\times \Delta T} \times 10^{6}\times [\text{ppm/°C}]$ High permittivity Capacitance value at each step shall be measured in thermal equilibrium, and the temperature characteristic shall be calculated from the following equation.			
and Remarks	Step Temperature			
	1 Minimum operating temperature 2 25°C			
	3 Maximum operating temperature			
	$\frac{(C-C_2)}{C_2} \times 100(\%)$			
	C : Capacitance value in Step 1 or Step 3			
	C2 : Capacitance value in Step 2			

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9. Deflection

Temperature Compensating (High Frequency type)

Appearance : No abnormality

:±5% or ±0.5pF, whichever is larger. Capacitance change

Specified Value

High permittivity

Appearance : No abnormality Capacitance change : Within ± 10%

Warp

: 1mm (Soft Termination type:3mm)

Duration : 10sec.

Test board : Glass epoxy-resin substrate

Test Methods and Remarks

Thickness : 1.6mm

(Unit: mm)

Capacitance measurement shall be conducted with the board bent.

10. Adhesive Strength of Terminal Electrodes

Specified Value No terminal separation or its indication.

Test Methods Applied force

and Remarks Duration : 30±5sec. (Soft Termination type: 10±1sec)

11. Vibration

and Remarks

Specified Value Initial performance shall be satisfied. Preconditioning

Test Methods

: Thermal treatment (at 150°C for 1hr) Note1 (Only High permittivity)

Frequency range : 10 to 55 Hz Overall amplitude : 1.5 mm

: 10 to 55 to 10 Hz for 1 min Sweeping method

Two hours each in X, Y, Z directions: 6 hrs in total

12. Solderability

Specified Value At least 95% of terminal electrode is covered by new solder

Test Methods and Remarks

	Eutectic solder	Lead-free solder
Solder type	H60A or H63A	Sn-3.0Ag-0.5Cu
Solder temperature	230±5°C	245±3°C
Duration	4±1	sec.

13. Resistance to Soldering

Temperature Compensating (High Frequency type)

Appearance : No abnormality

: Within $\pm 2.5\%$ or $\pm 0.25 pF$, whichever is larger. Capacitance change

Insulation resistance : Initial value

Withstanding voltage (between terminals): No abnormality

Specified Value

High permittivity

: No abnormality **Appearance**

: Within $\pm 15\%$ (H), $\pm 10\%$ (Q, S) Capacitance change

Dissipation factor : Initial value Insulation resistance : Initial value

Withstanding voltage (between terminals): No abnormality

Test Methods and Remarks

Preconditioning Solder temperature : Thermal treatment(at 150°C for 1hr) Note1 (Only High permittivity) : 270±5°C

: 3±0.5sec. Duration

: 80 to 100°C, 2 to 5 min. 150 to 200°C, 2 to 5min. Preheating conditions

Recovery : 24 ± 2hrs under the standard condition Note3

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14. Temperature Cycle (Thermal Shock)

Temperature Compensating (High Frequency type)

Appearance : No abnormality

Capacitance change : Within $\pm 2.5\%$ or ± 0.25 pF, whichever is larger.

Insulation resistance : Initial value

Withstanding voltage (between terminals): No abnormality

Specified Value

High permittivity

Appearance : No abnormality

Capacitance change : Within ± 15%(H), ±7.5%(Q, S)

Dissipation factor : Initial value Insulation resistance : Initial value

Withstanding voltage (between terminals): No abnormality

Preconditioning : Thermal treatment (at 150°C for 1hr) Note1 Conditions for 1 cycle

Test Methods and Remarks

Step	temperature(°C)	Time (min.)
1	Minimum operating temperature	30±3min.
2	Normal temperature	2 to 3min.
3	Maximum operating temperature	30±3min.
4	Normal temperature	2 to 3min.

Number of cycles: 50 times

Recovery : 24 ± 2 hrs under the standard condition Note3

15. Humidity (Steady state)

Temperature Compensating (High Frequency type)

Appearance : No abnormality

Capacitance change : Within $\pm 5\%$ or ± 0.5 pF, whichever is larger.

Insulation resistance : $1000M \Omega \min$

Specified Value

High permittivity

Preconditioning

 $\begin{tabular}{lll} Appearance & : No abnormality \\ Capacitance change & : Within $\pm 15\%$ \\ \end{tabular}$

Dissipation factor : 7%max(H), 5%max(Q, S).

Insulation resistance : $25 \mathrm{M}\,\Omega$ μ F or $1000 \mathrm{M}\,\Omega$, whichever is smaller.

Test Methods and Remarks

Temperature : $40\pm2^{\circ}$ C Humidity : 90 to 95%RH Duration : 500 + 24/-0 hrs

Recovery : 24±2hrs under the standard condition Note3

16. Humidity Loading

Temperature Compensating (High Frequency type)
Appearance : No abnormality

 $\text{Capacitance change} \qquad : \text{C} \leqq 2.0 \text{pF} : \pm 0.4 \text{pF} \quad 2.0 \text{pF} < \text{C} < 10 \text{pF} : \pm 0.75 \text{pF} \quad \text{C} \geqq 10 \text{pF} : \pm 7.5 \%$

: Thermal treatment(at 150°C for 1hr) Note1 (Only High permittivity)

(C: Nominal capacitance)

Specified Value

High permittivity

Insulation resistance

Appearance : No abnormality
Capacitance change : Within±15%

Dissipation factor : 7%max(H), 5%max(Q, S).

Insulation resistance : $10M\Omega \mu F$ or $500M\Omega$, whichever is smaller.

Preconditioning : Voltage treatment Note2 (Only High permittivity)

: $500M\Omega$ min

Test Methods and Remarks

 $\begin{array}{lll} \mbox{Temperature} & : 60 \pm 2 ^{\circ} \mbox{C} \\ \mbox{Humidity} & : 90 \mbox{ to } 95 \mbox{RH} \\ \mbox{Duration} & : 500 \mbox{ } +24 / -0 \mbox{ hrs} \\ \mbox{Applied voltage} & : \mbox{Rated voltage} \\ \end{array}$

Charge/discharge current : 50mA max.

Recovery : 24±2hrs under the standard condition Note3

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17. High Tempera	ature Loading			
	Temperature Compensating	(High Frequency type)		
	Appearance	: No abnormality		
	Capacitance change	: Within $\pm 3\%$ or ± 0.3 pF, whichever is larger.		
	Insulation resistance	:1000M Ω min		
Specified Value	Lliab manaittivity			
	High permittivity Appearance	: No abnormality		
	Capacitance change	: Within±15%		
	Dissipation factor	: 7%max(H), 5%max(Q, S).		
	Insulation resistance	± 50 M Ω μ F or ± 100 M Ω , whichever is smaller.		
	Preconditioning	: Voltage treatment Note2 (Only High permittivity)		
	Temperature	: Maximum operating temperature		
Test Methods	Duration	: 1000 + 24/-0 hrs		
and Remarks	Applied voltage	: Rated voltage×2(H, Q(High frequency / low loss type))		
and Remarks		Rated voltage \times 1.5(Q(Excluding High frequency / low loss type)), Rated voltage \times 1.2(S)		
	Charge/discharge current	: 50mA max.		
	Recovery	: 24±2hrs under the standard condition Note3		
Note1 Thermal tr		measured after test sample is heat-treated at $150+0/-10^{\circ}\mathrm{C}$ for an hour and kept at room temperature		
	for 24 ± 2 hours.			
Note2 Voltage tre		measured after test sample is voltage-treated for an hour at both the temperature and voltage specified in		
		and kept at room temperature for 24±2hours.		
Note3 Standard of	•	'5°C, Relative humidity: 45 to 85 % RH, Air pressure: 86 to 106kPa		
	·	stions concerning measurement results, in order to provide correlation data, the test shall be conducted		
	under the following o			
	•	°C, Relative humidity: 60 to 70 % RH, Air pressure: 86 to 106kPa		
	Unless otherwise sp	ecified, all the tests are conducted under the "standard condition".		

PRECAUTIONS

1. Circuit Design

- ◆Verification of operating environment, electrical rating and performance
 - 1. A malfunction of equipment in fields such as medical, aerospace, nuclear control, etc. may cause serious harm to human life or have severe social ramifications

Therefore, any capacitors to be used in such equipment may require higher safety and reliability, and shall be clearly differentiated from them used in general purpose applications.

Precautions

- ◆Operating Voltage (Verification of Rated voltage)
 - 1. The operating voltage for capacitors must always be their rated voltage or less.
 - If an AC voltage is loaded on a DC voltage, the sum of the two peak voltages shall be the rated voltage or less. For a circuit where an AC or a pulse voltage may be used, the sum of their peak voltages shall also be the rated voltage or less.
 - 2. Even if an applied voltage is the rated voltage or less reliability of capacitors may be deteriorated in case that either a high frequency AC voltage or a pulse voltage having rapid rise time is used in a circuit.

2. PCB Design

Precautions

- ◆Pattern configurations (Design of Land-patterns)
 - 1. When capacitors are mounted on PCBs, the amount of solder used (size of fillet) can directly affect the capacitor performance. Therefore, the following items must be carefully considered in the design of land patterns:
 - (1) Excessive solder applied can cause mechanical stresses which lead to chip breaking or cracking. Therefore, please consider appropriate land-patterns for proper amount of solder.
 - (2) When more than one component are jointly soldered onto the same land, each component's soldering point shall be separated by solder-resist.
- ◆Pattern configurations (Capacitor layout on PCBs)

After capacitors are mounted on boards, they can be subjected to mechanical stresses in subsequent manufacturing processes (PCB cutting, board inspection, mounting of additional parts, assembly into the chassis, wave soldering of the boards, etc.). For this reason, land pattern configurations and positions of capacitors shall be carefully considered to minimize stresses.

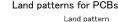
◆Pattern configurations (Design of Land-patterns)

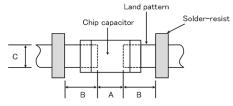
The following diagrams and tables show some examples of recommended land patterns to prevent excessive solder amounts.

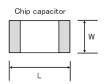
- (1) Recommended land dimensions for typical chip capacitors
- Multilayer Ceramic Capacitors : Recommended land dimensions (unit: mm)

Wave-soldering

Type		1608	2012	3216	3225
C: L		1.6	2.0	3.2	3.2
Size	W	0.8	1.25	1.6	2.5
-	4	0.8 to 1.0	1.0 to 1.4	1.8 to 2.5	1.8 to 2.5
В		0.5 to 0.8	0.8 to 1.5	0.8 to 1.7	0.8 to 1.7
С		0.6 to 0.8	0.9 to 1.2	1.2 to 1.6	1.8 to 2.5







Technical considerations

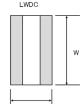
Reflow-soldering

Т	уре	0201	0402	0603	1005	1608	2012	3216	3225	4532
Size	L	0.25	0.4	0.6	1.0	1.6	2.0	3.2	3.2	4.5
SIZE	W	0.125	0.2	0.3	0.5	0.8	1.25	1.6	2.5	3.2
	Α	0.095~0.135	0.15~0.25	0.20~0.30	0.45~0.55	0.6~0.8	0.8~1.2	1.8~2.5	1.8~2.5	2.5~3.5
	В	0.085~0.125	0.10~0.20	0.20~0.30	0.40~0.50	0.6~0.8	0.8~1.2	1.0~1.5	1.0~1.5	1.5~1.8
	С	0.110~0.150	0.15~0.30	0.25~0.40	0.45~0.55	0.6~0.8	0.9~1.6	1.2~2.0	1.8~3.2	2.3~3.5

Note: Recommended land size might be different according to the allowance of the size of the product.

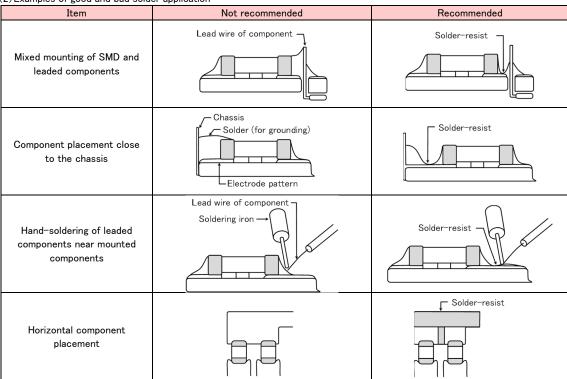
●LWDC: Recommended land dimensions for reflow-soldering (unit: mm)

Ту	ре	0510	0816	1220
Size	┙	0.52	0.8	1.25
Size	W	1.0	1.6	2.0
1	١	0.18~0.22	0.25~0.3	0.5~0.7
В		0.2~0.25	0.3~0.4	0.4~0.5
С		0.9~1.1	1.5~1.7	1.9~2.1



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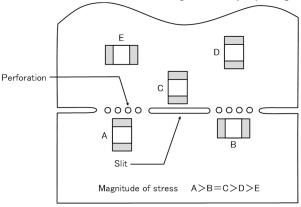
(2) Examples of good and bad solder application



- ◆Pattern configurations (Capacitor layout on PCBs)
 - 1-1. The following is examples of good and bad capacitor layouts; capacitors shall be located to minimize any possible mechanical stresses from board warp or deflection.

Items	Not recommended	Recommended
Deflection of board		Place the product at a right angle to the direction of the anticipated mechanical stress.

1-2. The amount of mechanical stresses given will vary depending on capacitor layout. Please refer to diagram below.



1-3. When PCB is split, the amount of mechanical stress on the capacitors can vary according to the method used. The following methods are listed in order from least stressful to most stressful: push-back, slit, V-grooving, and perforation. Thus, please consider the PCB, split methods as well as chip location.

3. Mounting

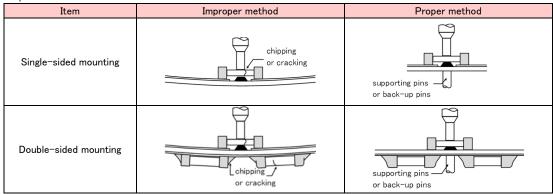
- ◆Adjustment of mounting machine
 - 1. When capacitors are mounted on PCB, excessive impact load shall not be imposed on them.
 - 2. Maintenance and inspection of mounting machines shall be conducted periodically.

Precautions

- ◆Selection of Adhesives
 - 1. When chips are attached on PCBs with adhesives prior to soldering, it may cause capacitor characteristics degradation unless the following factors are appropriately checked: size of land patterns, type of adhesive, amount applied, hardening temperature and hardening period. Therefore, please contact us for further information.
- This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

◆Adjustment of mounting machine

- 1. When the bottom dead center of a pick-up nozzle is too low, excessive force is imposed on capacitors and causes damages. To avoid this, the following points shall be considerable.
 - (1) The bottom dead center of the pick-up nozzle shall be adjusted to the surface level of PCB without the board deflection.
 - (2) The pressure of nozzle shall be adjusted between 1 and 3 N static loads.
 - (3) To reduce the amount of deflection of the board caused by impact of the pick-up nozzle, supporting pins or back-up pins shall be used on the other side of the PCB. The following diagrams show some typical examples of good and bad pick-up nozzle placement:



Technical considerations

2. As the alignment pin is worn out, adjustment of the nozzle height can cause chipping or cracking of capacitors because of mechanical impact on the capacitors.

To avoid this, the monitoring of the width between the alignment pins in the stopped position, maintenance, check and replacement of the pin shall be conducted periodically.

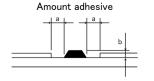
◆Selection of Adhesives

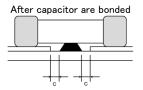
Some adhesives may cause IR deterioration. The different shrinkage percentage of between the adhesive and the capacitors may result in stresses on the capacitors and lead to cracking. Moreover, too little or too much adhesive applied to the board may adversely affect components. Therefore, the following precautions shall be noted in the application of adhesives.

- (1) Required adhesive characteristics
 - a. The adhesive shall be strong enough to hold parts on the board during the mounting & solder process.
 - b. The adhesive shall have sufficient strength at high temperatures.
 - c. The adhesive shall have good coating and thickness consistency.
 - d. The adhesive shall be used during its prescribed shelf life.
 - e. The adhesive shall harden rapidly.
 - f. The adhesive shall have corrosion resistance.
 - g. The adhesive shall have excellent insulation characteristics.
 - h. The adhesive shall have no emission of toxic gasses and no effect on the human body.
- (2) The recommended amount of adhesives is as follows;

[Recommended condition]

Figure	2012/3216 case sizes as examples
а	0.3mm min
b	100 to 120 μ m
С	Adhesives shall not contact land





4. Soldering

Precautions

Technical

considerations

◆Selection of Flu

Since flux may have a significant effect on the performance of capacitors, it is necessary to verify the following conditions prior to use;

- (1) Flux used shall be less than or equal to 0.1 wt%(in CI equivalent) of halogenated content. Flux having a strong acidity content shall not be applied.
- (2) When shall capacitors are soldered on boards, the amount of flux applied shall be controlled at the optimum level.
- (3) When water-soluble flux is used, special care shall be taken to properly clean the boards.

◆Soldering

Temperature, time, amount of solder, etc. shall be set in accordance with their recommended conditions.

Sn-Zn solder paste can adversely affect MLCC reliability.

Please contact us prior to usage of Sn-Zn solder.

◆Selection of Flux

1-1. When too much halogenated substance (Chlorine, etc.) content is used to activate flux, or highly acidic flux is used, it may lead to corrosion of terminal electrodes or degradation of insulation resistance on the surfaces of the capacitors.

- 1-2. Flux is used to increase solderability in wave soldering. However if too much flux is applied, a large amount of flux gas may be emitted and may adversely affect the solderability. To minimize the amount of flux applied, it is recommended to use a flux-bubbling system.
- 1-3. Since the residue of water-soluble flux is easily dissolved in moisture in the air, the residues on the surfaces of capacitors in high humidity conditions may cause a degradation of insulation resistance and reliability of the capacitors. Therefore, the cleaning methods

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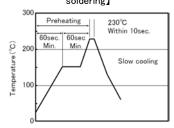
and the capability of the machines used shall also be considered carefully when water-soluble flux is used.

♦Soldering

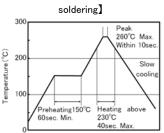
- · Ceramic chip capacitors are susceptible to thermal shock when exposed to rapid or concentrated heating or rapid cooling.
- · Therefore, the soldering must be conducted with great care so as to prevent malfunction of the components due to excessive thermal shock
- Preheating: Capacitors shall be preheated sufficiently, and the temperature difference between the capacitors and solder shall be within 130°C.
- · Cooling: The temperature difference between the capacitors and cleaning process shall not be greater than 100°C.

[Reflow soldering]

【Recommended conditions for eutectic soldering】

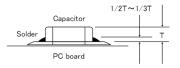


[Recommended condition for Pb-free



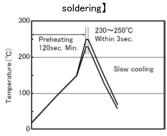
Caution

- ①The ideal condition is to have solder mass (fillet) controlled to 1/2 to 1/3 of the thickness of a capacitor.
- ②Because excessive dwell times can adversely affect solderability, soldering duration shall be kept as close to recommended times as possible, soldering for 2 times.

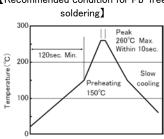


[Wave soldering]

[Recommended conditions for eutectic



[Recommended condition for Pb-free

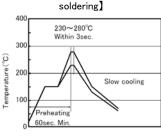


Caution

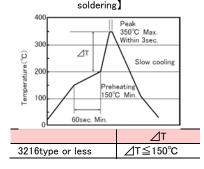
①Wave soldering must not be applied to capacitors designated as for reflow soldering only. soldering for 1 times.

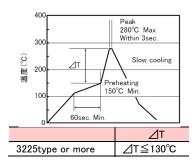
[Hand soldering]

[Recommended conditions for eutectic



[Recommended condition for Pb-free





Caution

- ①Use a 50W soldering iron with a maximum tip diameter of 1.0 mm.
- ②The soldering iron shall not directly touch capacitors. soldering for 1 times.

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5. Cleaning ◆Cleaning conditions 1. When PCBs are cleaned after capacitors mounting, please select the appropriate cleaning solution in accordance with the intended use Precautions of the cleaning. (e.g. to remove soldering flux or other materials from the production process.) 2. Cleaning condition shall be determined after it is verified by using actual cleaning machine that the cleaning process does not affect capacitor's characteristics. 1. The use of inappropriate cleaning solutions can cause foreign substances such as flux residue to adhere to capacitors or deteriorate their outer coating, resulting in a degradation of the capacitor's electrical properties (especially insulation resistance). 2. Inappropriate cleaning conditions (insufficient or excessive cleaning) may adversely affect the performance of the capacitors. In the case of ultrasonic cleaning, too much power output can cause excessive vibration of PCBs which may lead to the cracking of Technical considerations capacitors or the soldered portion, or decrease the terminal electrodes' strength. Therefore, the following conditions shall be carefully Ultrasonic output: 20 W/l or les Ultrasonic frequency: 40 kHz or less Ultrasonic washing period: 5 min. or less

6. Resin coating and mold 1. With some type of resins, decomposition gas or chemical reaction vapor may remain inside the resin during the hardening period or while left under normal storage conditions resulting in the deterioration of the capacitor's performance. 2. When a resin's hardening temperature is higher than capacitor's operating temperature, the stresses generated by the excessive heat Precautions may lead to damage or destruction of capacitors. The use of such resins, molding materials etc. is not recommended.

7. Handling	
Precautions	 ◆Splitting of PCB 1. When PCBs are split after components mounting, care shall be taken so as not to give any stresses of deflection or twisting to the board. 2. Board separation shall not be done manually, but by using the appropriate devices. ◆Mechanical considerations Be careful not to subject capacitors to excessive mechanical shocks. (1) If ceramic capacitors are dropped onto a floor or a hard surface, they shall not be used. (2) Please be careful that the mounted components do not come in contact with or bump against other boards or components.

	♦Storage
Precautions	To maintain the solderability of terminal electrodes and to keep packaging materials in good condition, care must be taken to control temperature and humidity in the storage area. Humidity should especially be kept as low as possible. *Recommended conditions**
	Ambient temperature : Below 30°C Humidity : Below 70% RH
	The ambient temperature must be kept below 40°C. Even under ideal storage conditions, solderability of capacitor is deteriorated as time passes, so capacitors shall be used within 6 months from the time of delivery. *Ceramic chip capacitors shall be kept where no chlorine or sulfur exists in the air. 2. The capacitance values of high dielectric constant capacitors will gradually decrease with the passage of time, so care shall be taker to design circuits. Even if capacitance value decreases as time passes, it will get back to the initial value by a heat treatment at 150°C for 1hour.
Technical considerations	If capacitors are stored in a high temperature and humidity environment, it might rapidly cause poor solderability due to terminal oxidation and quality loss of taping/packaging materials. For this reason, capacitors shall be used within 6 months from the time of delivery. If exceeding the above period, please check solderability before using the capacitors.

Please check the guide regarding precautions for deflection test, soldering by spot heat, and so on.

单击下面可查看定价,库存,交付和生命周期等信息

>>Taiyo Yuden(太阳诱电)